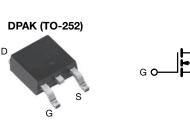
Vishay Siliconix



E Series Power MOSFET

PRODUCT SUMMARY			
V _{DS} (V) at T _J max.	550		
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.380	
Q _g max. (nC)	50		
Q _{gs} (nC)	6		
Q _{gd} (nC)	10		
Configuration	Single		



S N-Channel MOSFET

FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Low gate charge (Q_a)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Computing
 - PC silver box / ATX power supplies
- Lighting
 - Two stage LED lighting
- Consumer electronics
- Applications using hard switched topologies
 - Power factor correction (PFC)
 - Two switch forward converter
 - Flyback converter
- Switch mode power supplies (SMPS)

ORDERING INFORMATION Package DPAK (T

Package	DPAK (TO-252)
Lead (Pb)-free and halogen-free	SiHD12N50E-GE3
	SiHD12N50E-T1-GE3

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	500	V
Gate-source voltage			V _{GS}	± 30	v
Continuous dusin surrent (T 150 °C)	V at 10 V	$T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$	1	10.5	
Continuous drain current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 100 °C	I _D	6.6	А
Pulsed drain current ^a			I _{DM}	21	
Linear derating factor				0.91	W/°C
Single pulse avalanche energy ^b			E _{AS}	103	mJ
Maximum power dissipation			PD	114	W
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope $V_{DS} = 0 V \text{ to } 80 \% V_{DS}$		-1) / / -14	70	1//20	
Reverse diode dV/dt ^d			dV/dt	27	V/ns
Soldering recommendations (peak temperature) ^c for 10 s			300	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 2.7 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, dI/dt = 100 A/µs, starting T_J = 25 °C

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction to ambient	R _{thJA}	-	62	°C/W
Maximum junction to case (drain)	R _{thJC}	-	1.1	C/W

S21-1207-Rev. C, 13-Dec-2021

For technical questions, contact: <u>hvm@vishay.com</u>

Document Number: 91636



COMPLIANT HALOGEN

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PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		•			•	•	•
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	500	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.60	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μΑ	2.0	-	4.0	V
Onto norma lankana			$V_{GS} = \pm 20 V$	-	-	± 100	nA
Gate-source leakage	GSS		$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μA
Zava anto valtago dvoja ovvrant	1	V _{DS} =	= 500 V, V _{GS} = 0 V	-	-	1	μA
Zero gate voltage drain current	IDSS	V _{DS} = 400 \	/, V _{GS} = 0 V, T _J = 125 °C	-	-	10	
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 6 A	-	0.330	0.380	Ω
Forward transconductance	g fs	V _{DS}	s = 30 V, I _D = 6 A	-	3.1	-	S
Dynamic		•			•	•	•
Input capacitance	C _{iss}		V _{GS} = 0 V, V _{DS} = 100 V,		886	-	
Output capacitance	C _{oss}				52	-	
Reverse transfer capacitance	C _{rss}	f = 1 MHz		-	6	-	
Effective output capacitance, energy related ^a	C _{o(er)}	- V _{DS} = 0 V to 400 V, V _{GS} = 0 V		-	45	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}			-	131	-	1
Total gate charge	Qg				25	50	
Gate-source charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 6 \text{ A}, V_{DS} = 400 \text{ V}$		-	6	-	nC
Gate-drain charge	Q _{gd}			-	10	-	1
Turn-on delay time	t _{d(on)}			-	13	26	
Rise time	t _r	Vaa	V_{DD} = 400 V, I _D = 6 A, V _{GS} = 10 V, R _a = 9.1 Ω		16	32	
Turn-off delay time	t _{d(off)}				29	58	ns
Fall time	t _f		0	-	12	24	1
Gate input resistance	Rg	f = 1 MHz, open drain		-	0.92	-	Ω
Drain-Source Body Diode Characteristic	cs						
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	10.5	
Pulsed diode forward current	I _{SM}			_	-	21	- A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 7.5 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}			-	244	-	ns
Reverse recovery charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 6 \text{ A},$ dI/dt = 100 A/ μ s, V _R = 25 V		-	2.5	-	μC
Reverse recovery current	I _{RRM}			-	19	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

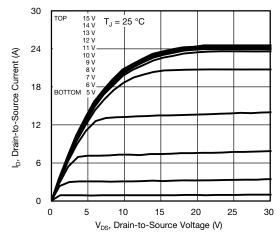


Fig. 1 - Typical Output Characteristics

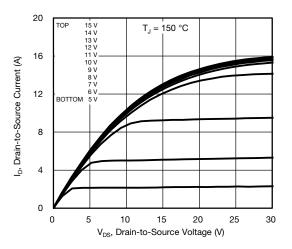


Fig. 2 - Typical Output Characteristics

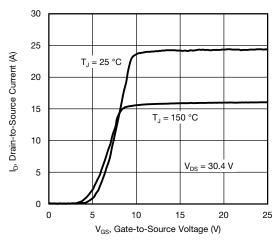


Fig. 3 - Typical Transfer Characteristics

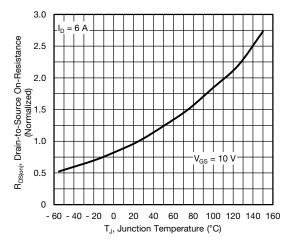


Fig. 4 - Normalized On-Resistance vs. Temperature

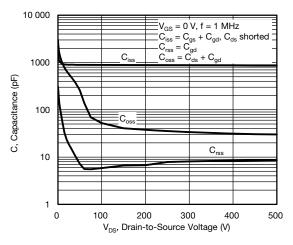


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

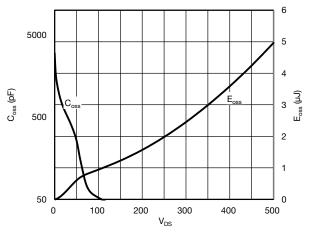


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

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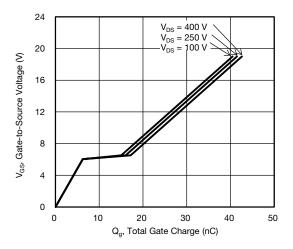


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

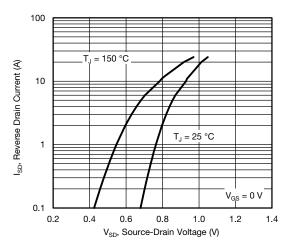


Fig. 8 - Typical Source-Drain Diode Forward Voltage

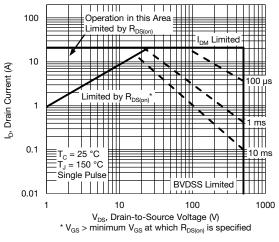


Fig. 9 - Maximum Safe Operating Area

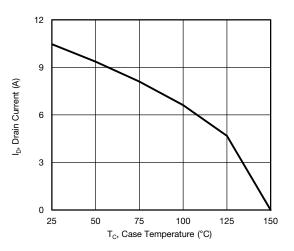


Fig. 10 - Maximum Drain Current vs. Case Temperature

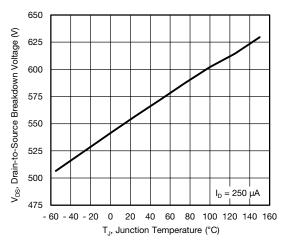


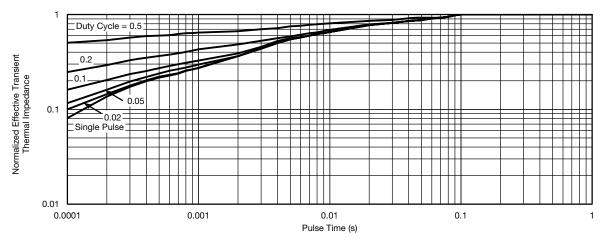
Fig. 11 - Temperature vs. Drain-to-Source Voltage

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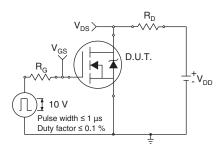


Fig. 13 - Switching Time Test Circuit

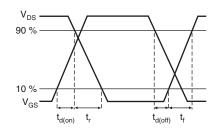


Fig. 14 - Switching Time Waveforms

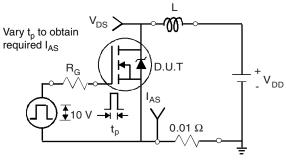


Fig. 15 - Unclamped Inductive Test Circuit

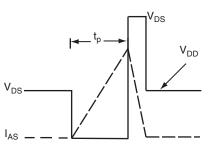


Fig. 16 - Unclamped Inductive Waveforms

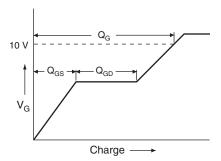
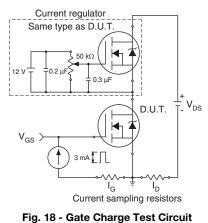


Fig. 17 - Basic Gate Charge Waveform



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Peak Diode Recovery dV/dt Test Circuit

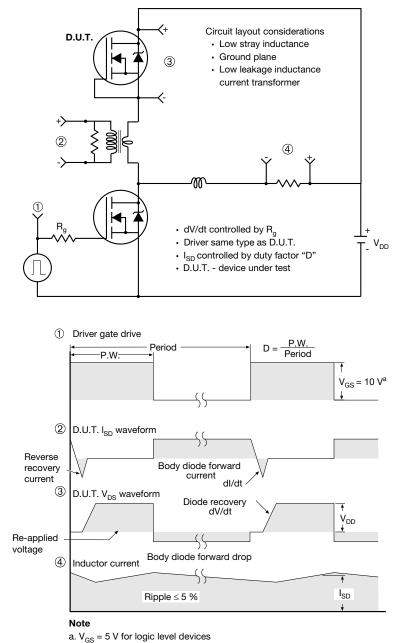


Fig. 19 - For N-Channel

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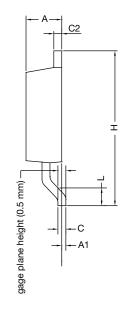


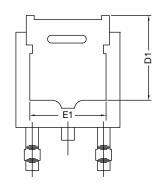


TO-252AA Case Outline

VERSION 1: FACILITY CODE = Y







	MILLIMETERS		
DIM.	MIN.	MAX.	
А	2.18	2.38	
A1	-	0.127	
b	0.64	0.88	
b2	0.76	1.14	
b3	4.95	5.46	
С	0.46	0.61	
C2	0.46	0.89	
D	5.97	6.22	
D1	4.10	-	
E	6.35	6.73	
E1	4.32	-	
Н	9.40	10.41	
е	2.28	BSC	
e1	4.56 BSC		
L	1.40	1.78	
L3	0.89	1.27	
L4	-	1.02	
L5	1.01	1.52	

Note

• Dimension L3 is for reference only



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VERSION 2: FACILITY CODE = N



	MILLIMETERS		
DIM.	MIN.	MAX.	
А	2.18	2.39	
A1	-	0.13	
b	0.65	0.89	
b1	0.64	0.79	
b2	0.76	1.13	
b3	4.95	5.46	
С	0.46	0.61	
c1	0.41	0.56	
c2	0.46	0.60	
D	5.97	6.22	
D1	5.21	-	
E	6.35	6.73	
E1	4.32	-	
e	2.29 BSC		
Н	9.94	10.34	

	MILLIMETERS		
DIM.	MIN.	MAX.	
L	1.50	1.78	
L1	2.74	l ref.	
L2	0.51	BSC	
L3	0.89	1.27	
L4	-	1.02	
L5	1.14	1.49	
L6	0.65	0.85	
θ	0°	10°	
θ1	0°	15°	
θ2	25°	35°	

Notes

• Dimensioning and tolerance confirm to ASME Y14.5M-1994

• All dimensions are in millimeters. Angles are in degrees

• Heat sink side flash is max. 0.8 mm

Radius on terminal is optional

ECN: E22-0399-Rev. R, 03-Oct-2022 DWG: 5347

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RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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